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## Cold sprayed Cu/Invar alloy composite



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#### ABSTRACT

Cold spray, an additive manufacturing technique based on plastic deformation of particles, was employed to prepare Cu/Invar alloy composites to avoid issues from other preparation methods, like undesirable thermal expansion anisotropy from the extrusion method and the excessive inter-diffusion between Cu and the Invar alloy from the sintering method. For the target  $Cu_x(Fe_64Ni_{36})_{100-x}(x = 30-70, wt\%)$  composites prepared by cold spray, the improved thermal expansion anisotropy was reflected by the negligible difference between the thermal expansion coefficient  $\alpha$  along and perpendicular to the spray direction, and simultaneously no obvious interdiffusion was observed between Cu and the Invar alloy Fe<sub>64</sub>Ni<sub>36</sub> after annealing at 500 °C. Both  $\alpha$  and the thermal conductivity *λ* increased slightly due to the release of internal stress and recrystallization of Cu. *α* of the annealed composites basically agreed with the theoretical predication, but *λ* was far below the values predicted by the Hasselman–Johnson model, mostly because the Invar alloy had an extraordinarily large surface area caused by impact deformation. Even so, the cold-sprayed Cu/Invar alloy composites had clearly advantageous comprehensive performance than those prepared by the traditional sintering and melting methods. Among Cu/ Invar alloy composites prepared by different methods, the annealed  $\text{Cu}_{50}(\text{Fe}_{64}\text{Ni}_{36})_{50}$  was the only composite having *λ* larger than 100 W/m•K and isotropic *α* smaller than 10 × 10<sup>-6</sup>/<sup>o</sup>C. In addition, the cold-sprayed Cu/ Invar alloy composites had a good plasticity (after annealing) that is rarely seen in traditional Cu-based composites with high thermal conductivity, presenting a good application potential for electronic packaging materials.

#### **1. Introduction**

Electronic packaging materials should ideally have high thermal conductivity *λ* to quickly conduct heat generated in the semiconductor chip [\[1\]](#page-10-0), and a low thermal expansion coefficient *α* matching that of the chip. In addition, weldability and processability are also important, which means the metallic or metal-based materials are preferable candidates [\[2,3](#page-10-0)]. Among metallic materials, Cu has a high *λ* of 397 W/m⋅K, second only to silver, but a large  $\alpha$  of 17  $\times$  10<sup>-6</sup>/<sup>o</sup>C; on the other hand, the Fe<sub>64</sub>Ni<sub>36</sub> (wt.%) Invar alloy has the lowest  $\alpha$  of  $1.2 \times 10^{-6}$  /  $^{\rm o}$ C around room temperature among metallic materials [[4](#page-10-0),[5](#page-10-0)], but a low *λ* of 11 W/m⋅K. Intuitively, Cu/Invar alloy composites could achieve a decent balance between high *λ* and low *α*. Fabricating Cu/Invar alloy composites with good comprehensive properties is, however, not an easy task.

The sandwich-structured Cu/Invar alloy/Cu, known as CIC, is the simplest form of Cu/Invar alloy composites [\[6,7](#page-10-0)]. It has good heat dissipation in the plane direction but has poor heat conduction in the thickness direction. To address this issue, the powder metallurgy technique was employed to fabricate isotropic Cu/Invar alloy composites [8–[13](#page-11-0)]. The sintering was usually done at 800  $\degree$ C or higher temperatures, which is essential for densification. The high sintering temperature, however, also accelerated the inter-diffusion between Cu and the Invar alloy. The diffusion of Fe and Ni from the Invar alloy into Cu significantly lowered *λ* of Cu, while the diffusion of Cu into the Invar alloys on the other hand increased  $\alpha$  of the Invar alloy. Applying a silver barrier layer on the Invar alloy powders was employed to reduce the inter-diffusion, but it was not effective  $[11-13]$  $[11-13]$ . As the state of the art, a commercial Cu/Invar alloy composite known as CUVAR® has so far the best comprehensive performance [\[14\]](#page-11-0). CUVAR® is produced by several

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steps [[15\]](#page-11-0). Cu and Invar alloy powders are firstly blended according to the composition of  $Cu_{43}(Fe_{64}Ni_{36})_{57}$  (wt%), vacuum sealed in a copper tube, heated to about 650 ◦C, at which temperature the inter-diffusion between Cu and the Invar alloy is negligible, extruded with a reduction ratio of 16:1, and finally annealed at 426–538 ◦C for about 0.5 h to release the internal stress. The thus produced CUVAR® is fully dense and has a *λ* of 120 W/m⋅K, which is better than that of most Cu/Invar alloy composites fabricated by other methods. Unfortunately, the severe elongation of the Invar alloy phase along the extrusion direction results in a 14% lower *α* in this direction, compared to *α* in the direction perpendicular to the extrusion direction. The anisotropy of *α* would result in thermal stress during thermocycling and thus pose a risk of device failure.

Two challenges for improvements are identified from the descriptions above. First, densification needs to be done at temperatures below 800 ◦C, using techniques other than high temperature sintering, to prevent undesirable inter-diffusion between Cu and the Invar alloy. Second, elongation of the Invar alloy phase along a specific direction should be avoided, which means extrusion and rolling are out of consideration. Cold spray [16–[18](#page-11-0)], an additive manufacturing based on the local plastic deformation of particles, is a feasible way to tackle both challenges. The particles are accelerated by high-pressure inert gas through a Laval nozzle and then deposited on a substrate. The deposition mechanism is based on severe plastic deformation of particles induced by high-speed impact, which is significantly different with particles being melted as in the case of thermal spray. The term "cold" essentially means the particles are solid, rather than liquid, before deposition. Indeed, the particles are usually heated, by hot inert gas, to achieve better plasticity. Compared to thermal spray, cold spray has several advantages, including little increase in the oxygen content, minimum temperature increase during deposition and thus little diffusion or phase transition, and high deposition speed and thus easy fabrication of bulk samples with a large volume or a large area. Both Cu and Invar alloys have good plasticity, due to their face centered cubic (fcc) structure, and they are suitable for cold spray. Indeed, the cold sprayed Cu and Invar alloys already exhibited high thermal conductivity [[19\]](#page-11-0) and low thermal expansion coefficient [\[20](#page-11-0)], respectively. Therefore, it is expected that cold sprayed Cu/Invar alloy composites could have a decent balance of high thermal conductivity and low thermal expansion coefficient, which motivates the current work.

#### **2. Experimental details**

Cu and  $Fe<sub>64</sub>Ni<sub>36</sub>$  powders were first blended according to the compositions of  $Cu_x(Fe_64Ni_{36})_{100-x}(x = 20, 30, 40, 50, 60, 70, wt\%)$ , and then sprayed using the parameters list in Table 1. The deposited materials, with a dimension of 100  $\times$  70  $\times$  (8–10) mm $^3$ , were removed from the Al substrate and then cut into small pieces with a dimension of 10  $\times$  $10 \times 2$  mm<sup>3</sup> along the horizontal cross-section and  $10 \times 8 \times 2$  mm<sup>3</sup> along the vertical cross-section. The small piece samples were vacuum sealed in quartz tubes and annealed at 500 ℃ for 3 h and 950 °C for 3 h, respectively. The microstructure and phase constitution of as-sprayed and annealed samples were analyzed by optical microscope (OM, LEICA DMI 3000 M), scanning electron microscope (SEM, ZEISS EVO 18) and X-ray diffractometer (XRD, Bruker D8 Advance,  $40KV \times 200$ mA), respectively. The X-ray computed tomography (XCT, ZEISS XRA-DIA 620 VERSA, 140KV  $\times$  150 µA) with a spatial resolution of 0.9975 μm was employed to analyze the inner microstructure of an as-sprayed

 $Cu_{50}(Fe_{64}Ni_{36})_{50}$  (Cu50 for short) sample with a dimension of  $\Phi$ 1.2 mm × 5 mm. *α* was measured by dilatometer (NETZSCH DIL 402C) using a heating rate of 5K/min and a load of 200 mN. *λ* at room temperature was determined using the formula  $\lambda = \rho \times D \times C$ , where the density  $\rho$ was measured using the Archimedes method, and the thermal diffusivity *D* and the specific heat capacity *C* were measured using a laser flash thermal conductivity measurement apparatus (NETZSCH LFA457). Tensile tests were carried out on the Cu50 sample using a universal testing machine (MTS, CMT5205) with an initial strain rate of  $1\times10^{-3}/$ s.

#### **3. Results and discussion**

#### *3.1. Microstructure*

[Fig. 1](#page-3-0) shows that the raw Cu and Invar alloy powders had a good degree of sphericity and narrow particle size distribution.  $D_{50}$  of Cu and Invar alloy powders were 37.6 and 36.7 μm respectively, which are suitable particle sizes for cold spray. The deposited materials showed color change with varying compositions but all of them showed no sign of visible oxidation, which is an advantage of cold spray.

The backscattered electron (BSE) images in [Fig. 2](#page-3-0) show that the dark Invar alloy phase and the light Cu phase were uniformly distributed, and the shape of two phases were in stark contrast with the initial spherical form shown in [Fig. 1](#page-3-0). When a high-speed powder impacts on the substate, the large impact force results in a crowding-out effect of the powder, which was widely verified by extensive observations in single powder cold spray  $[21-23]$  $[21-23]$ . As indicated by the schematic in [Fig. 3](#page-4-0), when an Invar alloy powder and a Cu powder impact on the substrate in succession, the Invar alloy particles firstly change to a hat shape due to the crowding-out effect, and then to a bowl shape upon further impact compression from the Cu particles; when two Invar alloy powders impact in succession, a thick hat shape forms. The perfect bowl and thick hat shape of the Invar alloy particles occur only when two particles (Invar alloy/Cu or Invar alloy/Invar alloy) impact on the same spot. If not, as is the more common case, various shapes would occur, as shown in [Fig. 2](#page-3-0). On the other hand, since Cu is softer than the Invar alloy, the Cu particles experience more deformation, hence displaying more irregular shapes as seen in [Fig. 2](#page-3-0).

The severe impact deformation significantly changes the shape of raw particles and their surface area. The surface area change, however, can hardly be investigated by SEM. In addition, it is also difficult to distinguish whether the many black holes in the BSE images are formed during deposition or during sample preparation, since some loose particles may fall off during polishing. The XCT technique, which can detect the inner three-dimensional information of the bulk sample [[24\]](#page-11-0), was thus employed to carefully investigate the two phases, i.e., Cu and the Invar alloy, and the holes. The X-ray is dampened differently when passing through different materials, which mostly depends on the density and the damping factor of the materials. The transmission X-ray forms a projection at the detector behind the sample. With the sample rotation, multiple projections are gained and assembled to formulate a three-dimensional graph through a CT algorithm. On the other hand, slices along the radial and axial directions of the cylinder sample can be obtained by disassembling the three-dimensional graph.

As shown in the XCT slices in [Fig. 4](#page-4-0), the black, dark and lighter regions are holes, the Invar alloy and Cu, respectively, which is similar to the BSE images shown in [Fig. 2](#page-3-0). The difference is that it is affirmed now

**Table 1** 

Cold spray process parameters (PSC-1000L, Japan Plasma Technology Research Industry Co. Ltd).

Powders	Substrate	Gas	Pressure	Chamber	Sprayed	Gun Speed
				Temperature	Distance	
$Cu + Fe_{64}Ni_{36}$	Al	$N_2$	5 MPa	700 °C	$20 \text{ mm}$	$200$ mm/s

<span id="page-3-0"></span>

**Fig. 1.** (a1, a2) SEM images and (b1, b2) particle size distributions of the raw Cu and Invar alloy powders, and (c) the appearance of the cold sprayed Cu/Invar alloy composites.



**Fig. 2.** BSE images of the cold-sprayed  $\text{Cu}_x(\text{Fe}_64\text{Ni}_{36})_{100-x}$  composites. The measured x values are indicated in the brackets.

<span id="page-4-0"></span>

**Fig. 3.** Schematic of the deformation of the Invar alloy particles.



**Fig. 4.** XCT slices along the (a) radial and (b) axial directions in the Cu50 composite. The arrow of (a) denotes the spray direction.

that these holes were formed during deposition. The total volume fraction of the holes is 0.12%. If there is only one spherical hole with the same volume fraction in a 1-g composite, the surface area of this hole is 1.3 mm<sup>2</sup>. However, there were 201 small holes in the detected region as shown in [Fig. 5\(](#page-5-0)c), corresponding to 102550 holes in a 1-g composite. The detected total specific surface area for the holes thus dramatically increased to 147  $\text{mm}^2/\text{g}$ , as listed in [Table 2](#page-5-0).

More importantly, Cu and the Invar alloy also had extraordinarily large surface areas of 50465 and 76472  $\text{mm}^2\text{/g}$  respectively, which was attributed to two factors. One is that the raw particles already had large surface areas. As a comparation, the raw powders of the CUVAR® composite had diameter about an order of magnitude larger, and thus had surface area about an order of magnitude smaller, as listed in [Table 2](#page-5-0). The other is that the severe impact deformation made the surface areas of the particles increase about 4~6 times, larger than the increase of  $1~2$  times for the particles in CUVAR®, as listed in [Table 2](#page-5-0).

The large surface areas of the Invar alloy phase in the cold sprayed composite lowered the thermal conductivity significantly, which will be discussed later.

#### *3.2. Thermal expansion behavior*

The cold sprayed Cu/Invar alloy composites were formed by plastic deformation of particles, with a similar but different forming mechanism of CUVAR®. *α* was thus carefully examined along the vertical crosssection and horizontal cross-section, to check if anisotropy of thermal expansion also existed in the cold sprayed materials. The average *α* value in the temperature range of 20~100 ◦C, *α*20-100, which is an important parameter for electronic packaging materials [\[3\]](#page-10-0), were measured along two orientations. As shown in [Figs. 6 and 7,](#page-5-0) most composites had a close  $\alpha_{20\text{-}100}$  along two orientations, with a difference of 0.04–0.16  $\times$   $10^{-6}\mathrm{/^o C}$ that was negligible when considering the measurement error. However,

<span id="page-5-0"></span>

**Fig. 5.** 3D XCT graphics of (a) the Invar alloy, (b) Cu, and (c) holes in the as-sprayed Cu50 composite.

### **Table 2**

The volume and surface area of Cu, the Invar alloy phase, and holes in two Cu/Invar alloy composites.



Note.

①: Calculated based on 1 g composite.

 $\odot$ : Assuming a spherical powder with a diameter *d* (*d* = 300 μm) is extruded to a cylinder with a length *l* (*l* = 1726–6026 μm) and a radius *r* (*r* = 51~27 μm), where ln(*l*/ *d*) = 1.75–3 [[15\]](#page-11-0).



**Fig. 6.** Thermal dilation traces along the vertical cross-section and horizontal cross-section.



**Fig. 7.** *α*20-100 of the as-sprayed Cu/Invar alloy composites. The insets show the schematic of sample cutting, and an OM image of the sample surface cut along the horizontal cross-section.

for Cu20 containing 80 wt% of the Invar alloy phase, *α*20-100 measured along the horizontal cross-section was 0.5  $\times$   $10^{-6}\mathrm{/^o C}$  lower than that measured along the vertical cross-section, which could not be ignored. The Invar alloy phase was compressed along the vertical cross-section and stretched along the horizontal cross-section, as shown in [Figs. 2](#page-3-0)  [and 3,](#page-3-0) which resulted in a higher proportion of the Invar alloy phase and

thus a lower  $\alpha$  along the horizontal cross-section [[14](#page-11-0)]. The difference in  $\alpha$  between two orientations depends on the amount, shape and orientation of the Invar alloy phase. For the cold sprayed composites, the Invar alloy phase stretched along the horizontal cross-section but without preferred orientation, as shown by the OM image in [Fig. 6](#page-5-0). For CUVAR®, however, under the large true strain of 1.75–3, the spherical Invar alloy particles were extruded into a cylinder shape along the extrusion direction [[14\]](#page-11-0), showing much stronger preferred orientation than cold sprayed composites. Therefore, for CUVAR®, the difference in *α* between the longitudinal direction (i.e., extrusion direction) and transverse direction was as large as  $1.0 \times 10^{-6}$ /°C, even though the weight percentage of the Invar alloy phase was only 57%. By contrast, for cold sprayed composites, even when the weight percentage of the Invar alloy phase reached 80%, a mere difference of 0.5  $\times$   $10^{-6}\!/ {^o}\mathrm{C}$ between two orientations was seen. Other composites containing lower weight percentages of the Invar alloy phase could be deemed isotropic in terms of thermal expansion, and in the following text  $\alpha_{20-100}$  values measured along the horizontal cross-section were used.

#### *3.3. The effect of annealing*

Cold sprayed composites usually have a large internal stress due to severe plastic deformation of particles. Annealing is necessary to eliminate internal stress but has the possibility to also change the structure and property of the composites. As shown in Figs. 8 and  $9(a)$ , after annealing at 500 °C for 3 h, all composites had a slight increase in  $\alpha$ , due to the release of internal stress that otherwise could restrict the thermal expansion to some extent [\[25](#page-11-0)]. Actually, the cold spray pure Invar alloy has a negative  $\alpha$  if the compressive residual stress is large enough [\[20](#page-11-0)]. [Fig. 9\(](#page-7-0)b) shows that, after annealing at 500 ◦C for 3 h, Cu60 and Cu70 had a rather large increase in *λ*, while other composites had a marginal increase in *λ*. This phenomenon was mostly attributed to the morphology change of Cu after annealing. Due to the high strain rate up to  $10^6{\sim}10^9{\!/}s$  induced by the high velocity impact [[26,27\]](#page-11-0), the Cu grains broke into smaller pieces, as shown in Fig.  $10(a)$ . After annealing, the recrystallized Cu grains grew to formulate large and regular grains, as shown in [Fig. 10](#page-7-0)(b). More importantly, the interface between particles in the as-sprayed sample, as indicated by the arrows in Fig.  $10(a)$ ,



disappeared. Thus, the Cu phase could be deemed as a continuous matrix. Large grains with less grain boundaries are beneficial for the heat conduction [\[28](#page-11-0)], and this effect is even more significant when there is a higher volume percentage (*>*50 wt%) of the Cu phase. Therefore, Cu60 and Cu70 had a more significant increase in *λ* than other composites.

Annealing at 500 ◦C for 3 h did not change the compositions of each phase, since the EDS line scanning results shown in [Fig. 11](#page-7-0) were almost identical to those in the as-sprayed condition, and the XRD patterns shown in [Fig. 12](#page-8-0) also did not change much. Annealing at 950 ◦C for 3 h, however, caused a clear inter-diffusion among the three elements. For Cu50, the concentration of Cu is higher than that of Fe and Ni, hence the diffusion of Cu into the Invar alloy phase was more severe than that of Fe and Ni into the Cu phase, as shown in [Fig. 11](#page-7-0). The diffusion made the diffraction peaks of Cu and the Invar alloy phase, both having a fcc structure, merge into one peak, as shown in [Fig. 12.](#page-8-0) The atomic radius of Fe, Ni and Cu is 1.241, 1.246 and 1.278 Å, respectively. The diffusion of Fe and Ni into the Cu phase thus resulted in a lattice shrinkage, manifested by a right shift of the diffraction peak. The heterogenous atomic occupancy in the Cu lattice resulted in additional scattering and hence significantly lowered  $\lambda$  [\[13](#page-11-0)]. On the other hand, the inter-diffusion changed the composition of the Invar alloy phase, by increasing the Cu content and decreasing the Fe and Ni contents, and thus was harmful to the low thermal expansion characteristic. Consequently, after annealing at 950 ◦C for 3 h, there was a noticeable increase in *α*.

The mechanical properties also changed sharply after annealing. As shown in [Figs. 13 and 14](#page-8-0), the as-sprayed Cu50 had a high hardness, both in the Cu phase and the Invar phase, but a very low strength of 156 MPa without yielding in the tension test. Similar phenomenon, i.e., hard but brittle behavior was also found in the cold-sprayed pure Cu [[29\]](#page-11-0), and it was mostly attributed to the internal stress. The internal stress was generated from the mismatch of plastic deformation between Cu and the Invar phase. During deposition, the Cu phase underwent a more severe plastic deformation than the Invar phase, which can be deduced from two observations. One is the more irregular shapes of the Cu phase shown in the BSE photos of [Fig. 2](#page-3-0). The other is the hardness of the Cu phase decreased by about a half, while that of Invar phases only decreased by about one-third after annealing, which means the Cu phase was more deformed in the as-sprayed state. On the other hand, the strength and plasticity increased significantly after annealing. The tensile elongation of the annealed Cu50 was 15%, which was much inferior to the value of 40% of the cold-sprayed Cu after being annealed at  $500^{\circ}$ C for 4 h [\[30](#page-11-0)], but was rather close to the value of 21% of the cold-sprayed Invar alloy after being annealed at  $800^{\circ}$ C for 3 h [[20\]](#page-11-0). The ultimate tensile strength of annealed Cu50 was 428 MPa, which was, again, much larger than 250 MPa of the cold-sprayed and annealed Cu [\[30](#page-11-0)], and close to 472 MPa of the cold-sprayed and annealed Invar alloy [[20\]](#page-11-0). These phenomena indicated that the mechanical property of the annealed Cu50 is dominated by the Invar phase, which acts as the reinforcement phase and has a volume fraction larger than 50%.

#### *3.4. Theoretical models for α and λ*

After annealing at 500  $\,^{\circ}$ C for 3 h, there still had two distinct phases without significant inter-diffusion; the internal stress was released; the Cu particle boundaries were eliminated by recrystallization and a continuous Cu matrix formed. The Cu/Invar alloys composites were thus in a stable state and how the properties, i.e.,  $\alpha_{20-100}$  and  $\lambda$ , change with the compositions can now be investigated. There are several theoretical models proposed to describe the thermal expansion of the composites [31–[34\]](#page-11-0). The simplest one is the rule-of-mixture (ROM) model [\[34](#page-11-0)], given by

$$
\alpha_{\rm c} = \alpha_{\rm m} V_{\rm m} + \alpha_{\rm p} V_{\rm p} \tag{1}
$$

where  $\alpha$  and  $V$  are the thermal expansion coefficient and volume frac-**Fig. 8.** Thermal dilation traces of as-sprayed and annealed composites. tion, respectively, and subscripts c, m and p denote composite, matrix

<span id="page-7-0"></span>

**Fig. 9.** (a) *α* and (b) *λ* of as-sprayed and annealed composites.



**Fig. 10.** OM images of as-sprayed and annealed Cu50.



**Fig. 11.** EDS line scanning results of Cu50 in as-sprayed and annealed conditions.

(Cu) and secondary phase (Invar alloy), respectively. Effects of several factors on the thermal expansion are not taken into consideration in the ROM model, such as the holes, internal stress, elastic modulus difference between two phases, the shape of the secondary phase, etc. This simplest model, however, still works reasonably well as shown in [Fig. 15](#page-9-0)(a), indicating that these factors do not have a significant effect on the thermal expansion, at least for the cold sprayed Cu/Invar alloy

#### composites.

For *λ*, the Hasselman–Johnson (H–J) model [[35\]](#page-11-0) is a sophisticated one since in addition to the volume fraction of the secondary phase, the particle size and the interfacial thermal resistance (ITR) are also taken into consideration. It is expressed by

<span id="page-8-0"></span>

**Fig. 12.** XRD patterns of three composites in as-sprayed and annealed conditions.



**Fig. 13.** Hardness of Cu and the Invar phase in as-sprayed and annealed conditions.

$$
\lambda_{\rm c} = \lambda_{\rm m} \frac{\left[\lambda_{\rm p}(1+2\beta) + 2\lambda_{\rm m}\right] + 2V_{\rm p}\left[\lambda_{\rm p}(1-\beta) - \lambda_{\rm m}\right]}{\left[\lambda_{\rm p}(1+2\beta) + 2\lambda_{\rm m}\right] \cdot V_{\rm p}\left[\lambda_{\rm p}(1-\beta) - \lambda_{\rm m}\right]}
$$
\n(2) 
$$
\lambda_{\rm c} = \lambda_{\rm m} \frac{\left(\lambda_{\rm p} + 2\lambda_{\rm m}\right) - 2V_{\rm p}\left(\lambda_{\rm m} - \lambda_{\rm p}\right)}{\left(\lambda_{\rm p} + 2\lambda_{\rm m}\right) + V_{\rm r}\left(\lambda_{\rm m} - \lambda_{\rm p}\right)}
$$

where *λ* and *V* are the thermal conductivity and volume fraction, respectively, and subscripts c, m and p denote composite, matrix (Cu) and secondary phase (Invar alloy), respectively. The non-dimensional parameter *β* is defined as

$$
\beta = R_{\rm ITR} \cdot \lambda_{\rm m}/d \tag{3}
$$

where  $R_{\text{ITR}}$  and *d* are the specific ITR and the radius of the secondary phase particles, respectively. When the ITR is very small, i.e.,  $R_{\text{ITR}}$  $\rightarrow$ 0 and thus  $\beta \rightarrow$ 0, Eq (2) is simplified to

$$
\lambda_{\rm c} = \lambda_{\rm m} \frac{\left(\lambda_{\rm p} + 2\lambda_{\rm m}\right) \cdot 2V_{\rm p}\left(\lambda_{\rm m} \cdot \lambda_{\rm p}\right)}{\left(\lambda_{\rm p} + 2\lambda_{\rm m}\right) + V_{\rm p}\left(\lambda_{\rm m} \cdot \lambda_{\rm p}\right)}\tag{4}
$$

which is the Maxwell model [[36,37\]](#page-11-0), the simplest and well-known model for the thermal conductivity of composites. On the contrary, when the ITR is very large, i.e.,  $R_{\text{ITR}} \rightarrow \infty$  and thus  $\beta \rightarrow \infty$ , Eq (2) is simplified to

$$
\lambda_{\rm c} = 2\lambda_{\rm m} \frac{1 - V_{\rm p}}{2 + V_{\rm p}}\tag{5}
$$

All possible *λ* predicated by H-J model are included in a narrow region surrounded by two lines calculated based on Eqs. (4) and (5). The measured *λ*, however, are far below this theoretically predicted region.

<span id="page-9-0"></span>

**Fig. 14.** Tensile test results of as-sprayed and annealed Cu50. The inset photo shows the comparison of the untested sample and the annealed sample after failure.

The failure of the H-J model is mostly attributed to the underestimation of the total ITR. The total ITR depends on the physical property of the interface, i.e., the *R*<sub>ITR</sub>, and the total interfacial area. The H-J model is built based on a presumption of secondary phase in the form of spherical particles that are commonly seen in the powder metallurgy prepared composites [\[38](#page-11-0)]. In the H-J model, the total interfacial area only depends on the volume fraction *V*p and the radius *d* of the secondary phase. In cold sprayed composites, however, the Invar alloy phase had the bowl, hat and other shapes due to the severe plastic deformation, as shown in [Figs. 2 and 3](#page-3-0). The surface area of the Invar alloy phase increased about 4~6 times when comparing to that of the raw spherical powders, as indicated by [Table 2.](#page-5-0) Therefore, even at the limit of  $R_{\text{ITR}} \rightarrow \infty$ , the H-J model is unlikely to be accurate because only a small part of interface is counted in the model. Indeed, the distance between two lines calculated at the limits of  $R_{\text{ITR}} \rightarrow 0$  and  $R_{\text{ITR}} \rightarrow \infty$  is small, which

indicates that the role of ITR is insignificant in the H-J model, at least for the Cu/Invar alloy composites. In addition, another presumption of the H-J model is the fully dense composite without any holes. As listed in [Table 2,](#page-5-0) although holes had a volume fraction of only 0.12%, they had a rather large surface area, increasing more than 100 times when compared to a single spherical hole with the same volume. These holes have a large  $R_{\text{ITR}}$  and thus a non-negligible contribution to the total ITR, even though the total surface area of the holes is incomparable to that of the Invar alloy phase. In short, a theoretical model that can accurately describe the thermal conductivity of cold sprayed Cu/Invar alloy composites is still lacking and further investigations are warranted.

#### *3.5. Comprehensive properties*

[Fig. 16](#page-10-0) summarizes  $\alpha$  and  $\lambda$  of existing Cu/Invar alloy composites prepared by different methods [8–[14,39](#page-11-0),[40\]](#page-11-0). Pure Cu and the Invar alloy are connected by a theoretical line based on the simplest ROM and Maxwell models. Among dozens of Cu/Invar alloy composites, there is only one data point, i.e., CUVAR® along the longitude direction, falls on this theoretical line, indicating a challenging task for fabricating Cu/Invar alloy composite with theoretical *α* and *λ*. Another data point of CUVAR® along the transverse direction has  $\alpha$  1  $\times$   $10^{-6}$ /°C higher. The  $\alpha$ value of the cold sprayed Cu40, with a similar composition to CUVAR®, is 7.5 ×  $10^{-6}$ /°C, just between those of CUVAR® along two directions. Its *λ* of 64 W/m⋅K, however, is much inferior to 120 W/m⋅K of CUVAR®, mostly because the much larger surface area of the Invar alloy phase of the cold sprayed composite. Even so, the cold sprayed Cu/Invar alloy composites have clearly better comprehensive properties than those prepared by other methods including sintering and melting, mostly because the lower temperature needed by cold spray, as indicated by the legend of [Fig. 16](#page-10-0). For sintering, it is difficult to solve the conflict between high density and low inter-diffusion, since high pressure and high temperature are required by the former which are however harmful to the latter. Strictly speaking, the product of arc melting is not a composite, but an alloy containing Cu-rich and Invar alloy-rich phases [\[40](#page-11-0)], which results in low  $\lambda$ , as shown in the bottom part of [Fig. 16.](#page-10-0)

With the increasing power consumption of the chip, the minimum requirements for the heat sink are *λ* larger than 100 W/m⋅K and *α* lower than 10.0  $\times$   $10^{-6}\!/^o\mathrm{C}.$  The cold sprayed Cu50 after annealing at 500  $^\circ\mathrm{C}$ 



**Fig. 15.** Agreements between theoretical model predictions for *α* and *λ* and experimental measured values.

<span id="page-10-0"></span>

**Fig. 16.** *α* and *λ* of Cu/Invar alloy composites prepared by different methods.

for 3 h had *λ* of 104 W/m⋅K and  $\alpha$  of 9.2  $\times$   $10^{-6}$ /<sup>o</sup>C, which is the only Cu/ Invar alloy composite meeting these two requirements, if not considering CUVAR® which shows anisotropic *α* that would lead to thermal stress. *λ* could be further optimized by adjusting the cold spray technique, such as using larger Invar alloy powders to reduce the surface area, but are still much inferior to that of Cu/SiC [\[41](#page-11-0)], Cu/Diamond [[42\]](#page-11-0), Cu/W [[43\]](#page-11-0) and Cu/Mo [[44\]](#page-11-0) composites, due to the innate low *λ* of 11 W/m⋅K of the Invar alloy. However, the processability of Cu/Invar alloy composites, which is guaranteed by the good plasticity shown in [Fig. 14](#page-9-0), is much better than those Cu-based composites containing a hard secondary phase. In addition, a large volume or area of Cu/Invar alloy composites can be easily fabricated by cold spray, which is a unique advantage over other Cu-based composites. These features make the cold sprayed Cu/Invar alloy composites potentially useful in some special field, such as the cooling backboard of the large flat panel display.

#### **4. Conclusions**

In conclusion, two major issues of Cu/Invar alloy composites fabricated by traditional methods, i.e., anisotropic thermal expansion by the extrusion method, and the high temperature inter-diffusion between Cu and the Invar alloy by the sintering method, were tackled by using the cold spray method. A new problem, however, appeared in that the large surface area of the Invar alloy, introduced by impact deformation, resulted in a large interfacial thermal resistance and thus lowered the thermal conductivity significantly. Even so, among existing Cu/Invar alloy composites prepared by different methods, the annealed  $Cu_{50}(Fe_{64}Ni_{36})_{50}$  composite was the only material meeting requirements of  $\lambda$  larger than 100 W/m•K and isotropic  $\alpha$  smaller than 10  $\times$  10<sup>-6</sup>/<sup>o</sup>C. Together with the unique advantage of good processability, the cold sprayed Cu/Invar composites present a high application potential in the domain of electronic packaging materials.

#### **Declaration of competing interest**

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

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